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Vishay/Siliconix SI7664DP-T1-E3

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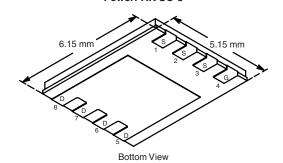


Vishay Siliconix

# N-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY     |                                   |                                 |                       |  |  |
|---------------------|-----------------------------------|---------------------------------|-----------------------|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}(\Omega)$              | I <sub>D</sub> (A) <sup>a</sup> | Q <sub>g</sub> (Typ.) |  |  |
| 30                  | 0.0031 at V <sub>GS</sub> = 10 V  | 40                              | 37 nC                 |  |  |
|                     | 0.0036 at V <sub>GS</sub> = 4.5 V | 40                              | 37 110                |  |  |

# PowerPAK SO-8



Ordering Information: Si7664DP-T1-E3 (Lead (Pb)-free)

Si7664DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

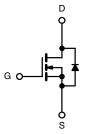
- Halogen-free available
- TrenchFET<sup>®</sup> Power MOSFET
- PWM Optimized



100 % R<sub>q</sub>, Capacitance and UIS Tested

#### **APPLICATIONS**

- Synchronous Low Side
  - Notebook
  - Server
  - Workstation



N-Channel MOSFET

| Parameter  | Symbol                            | Limit           | Unit                |    |  |
|--|-----------------------------------|-----------------|---------------------|----|--|
| Drain-Source Voltage   |                                   | V <sub>DS</sub> | 30                  | V  |  |
| Gate-Source Voltage  |                                   | V <sub>GS</sub> | ± 12                | ¬  |  |
|  | T <sub>C</sub> = 25 °C            |                 | 40                  |    |  |
| Continuous Drain Current (T <sub>.1</sub> = 150 °C)          | T <sub>C</sub> = 70 °C            | ı               | 32                  |    |  |
| Continuous Diam Current (1 <sub>J</sub> = 150°C)             | T <sub>A</sub> = 25 °C            | I <sub>D</sub>  | 31 <sup>b, c</sup>  |    |  |
|  | T <sub>A</sub> = 70 °C            |                 | 25 <sup>b, c</sup>  | _  |  |
| Pulsed Drain Current   |                                   | I <sub>DM</sub> | 70                  | A  |  |
| Cantinuous Course Drain Diada Current                        | T <sub>C</sub> = 25 °C            | I-              | 40                  |    |  |
| Continuous Source-Drain Diode Current                        | T <sub>A</sub> = 25 °C            | I <sub>S</sub>  | 4.9 <sup>b, c</sup> |    |  |
| Single Pulse Avalanche Current                               |                                   | I <sub>AS</sub> | 40                  |    |  |
| Single Pulse Avalanche Energy                                | L = 0.1 mH                        | E <sub>AS</sub> | 80                  | mJ |  |
| Maximum Power Dissipation                                    | T <sub>C</sub> = 25 °C            |                 | 83                  |    |  |
|  | T <sub>C</sub> = 70 °C            | ь               | 53                  | w  |  |
|  | T <sub>A</sub> = 25 °C            | P <sub>D</sub>  | 5.4 <sup>b, c</sup> |    |  |
|  | T <sub>A</sub> = 70 °C            |                 | 3.4 <sup>b, c</sup> |    |  |
| Operating Junction and Storage Temperature Ra                | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150     | °C                  |    |  |
| Soldering Recommendations (Peak Temperature) <sup>d, e</sup> |                                   | j               | 260                 |    |  |

| THERMAL RESISTANCE RATINGS                  |              |                   |         |         |      |  |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter                                   |              | Symbol            | Typical | Maximum | Unit |  |
| Maximum Junction-to-Ambient <sup>b, f</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 18      | 23      | °C/W |  |
| Maximum Junction-to-Case (Drain)            | Steady State | R <sub>thJC</sub> | 1.0     | 1.5     | ]    |  |

#### Notes:

- a. Based on T<sub>C</sub> = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See Solder Profile ( http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 65 °C/W.

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Datasheet of SI7664DP-T1-E3 - MOSFET N-CH 30V 40A PPAK SO-8

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## **Si7664DP**

# Vishay Siliconix



| Parameter   | Symbol                  | Test Conditions  | Min. | Тур.   | Max.   | Unit        |  |
|---|-------------------------|--|------|--------|--------|-------------|--|
| Static  | -                       |  |      |        |        |             |  |
| Drain-Source Breakdown Voltage                          | V <sub>DS</sub>         | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$  | 30   |        |        | V           |  |
| V <sub>DS</sub> Temperature Coefficient ΔV <sub>I</sub> |                         | 1 0504   |      | 35     |        |             |  |
| V <sub>GS(th)</sub> Temperature Coefficient             | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA  |      | 5.0    |        | mV/°C       |  |
| Gate-Source Threshold Voltage                           | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_D = 250 \mu A$   | 0.6  |        | 1.8    | V           |  |
| Gate-Source Leakage                                     | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$  |      |        | ± 100  | nA          |  |
| Zava Cata Valtaga Dusin Comment                         | I <sub>DSS</sub>        | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$ |      |        | 1      | μΑ          |  |
| Zero Gate Voltage Drain Current                         |                         |  |      |        | 10     |             |  |
| On-State Drain Current <sup>a</sup>                     | I <sub>D(on)</sub>      | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$  | 30   |        |        | Α           |  |
|   | R <sub>DS(on)</sub>     | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A  |      | 0.0025 | 0.0031 | Ω           |  |
| Drain-Source On-State Resistance <sup>a</sup>           |                         | $V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$   |      | 0.0029 | 0.0036 |             |  |
| Forward Transconductance <sup>a</sup>                   | 9 <sub>fs</sub>         | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A  |      | 108    |        | S           |  |
| Dynamic <sup>b</sup>                                    |                         |  |      |        |        |             |  |
| Input Capacitance                                       | C <sub>iss</sub>        |  |      | 5180   | 7770   | pF          |  |
| Output Capacitance                                      | C <sub>oss</sub>        | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$   |      | 880    | 1320   |             |  |
| Reverse Transfer Capacitance                            | C <sub>rss</sub>        |  |      | 305    | 458    |             |  |
| Table Cata Character                                    |                         | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A  |      | 85     | 125    | nC          |  |
| Total Gate Charge                                       | Qg                      |  |      | 38     | 55     |             |  |
| Gate-Source Charge                                      | $Q_{gs}$                | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$  |      | 10.5   |        |             |  |
| Gate-Drain Charge                                       | $Q_{gd}$                |  |      | 5.5    |        |             |  |
| Gate Resistance   | R <sub>g</sub>          | f = 1 MHz  |      | 0.95   | 1.5    | Ω           |  |
| Turn-On Delay Time                                      | t <sub>d(on)</sub>      |  |      | 14     | 21     |             |  |
| Rise Time   | t <sub>r</sub>          | $V_{DD}$ = 15 V, $R_{L}$ = 1.5 $\Omega$  |      | 100    | 150    |             |  |
| Turn-Off Delay Time                                     | t <sub>d(off)</sub>     | $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$   |      | 45     | 70     |             |  |
| Fall Time   | t <sub>f</sub>          |  |      | 8      | 15     |             |  |
| Turn-On Delay Time                                      | t <sub>d(on)</sub>      |  |      | 28     | 45     | ns          |  |
| Rise Time   | t <sub>r</sub>          | $V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$  |      | 103    | 155    | -<br>-<br>- |  |
| Turn-Off Delay Time                                     | t <sub>d(off)</sub>     | $I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$  |      | 41     | 65     |             |  |
| Fall Time   | t <sub>f</sub>          |  |      | 9      | 15     |             |  |
| <b>Drain-Source Body Diode Characteris</b>              | stics                   |  |      |        |        |             |  |
| Continuous Source-Drain Diode<br>Current                | I <sub>S</sub>          | T <sub>C</sub> = 25 °C   |      |        | 40     | А           |  |
| Pulse Diode Forward Current <sup>a</sup>                | I <sub>SM</sub>         |  |      |        | 70     |             |  |
| Body Diode Voltage                                      | $V_{SD}$                | I <sub>S</sub> = 5 A   |      | 0.73   | 1.1    | V           |  |
| Body Diode Reverse Recovery Time t <sub>rr</sub>        |                         |  |      | 35     | 55     | ns          |  |
| Body Diode Reverse Recovery Charge                      | Q <sub>rr</sub>         | L = 10 A di/dt = 100 A/vo T = 25 °C  |      | 35     | 55     | nC          |  |
| Reverse Recovery Fall Time                              | t <sub>a</sub>          | $I_F = 10 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$                                 |      | 18     |        | ns          |  |
| Reverse Recovery Rise Time                              | t <sub>b</sub>          | 1  |      | 17     |        |             |  |

#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

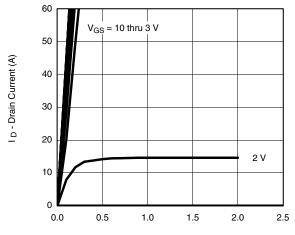
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



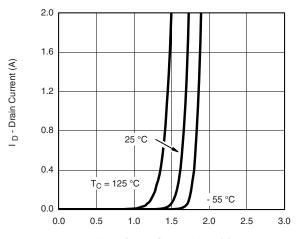


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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

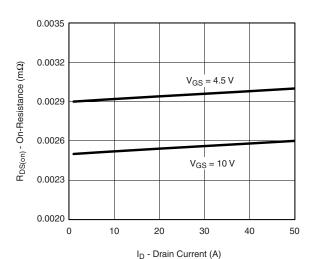


V<sub>DS</sub> - Drain-to-Source Voltage (V)

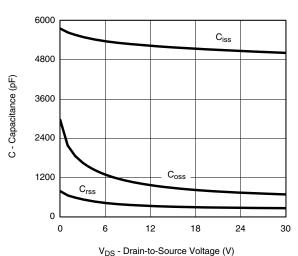


V<sub>GS</sub> - Gate-to-Source Voltage (V) **Transfer Characteristics** 



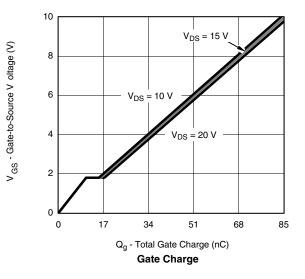


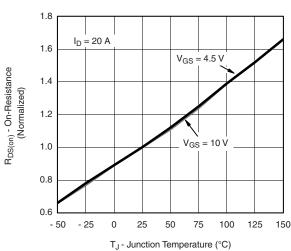
On-Resistance vs. Drain Current and Gate Voltage



VDS - Dialii-to-Source voltage (v)

#### Capacitance





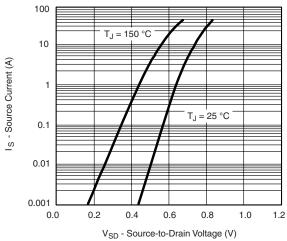
On-Resistance vs. Junction Temperature

Document Number: 73566 S-80438-Rev. B, 03-Mar-08

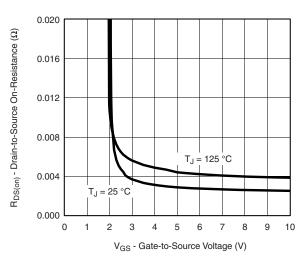


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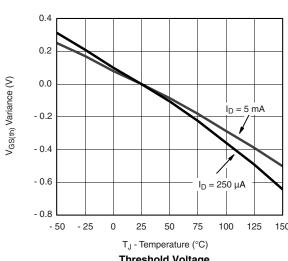
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



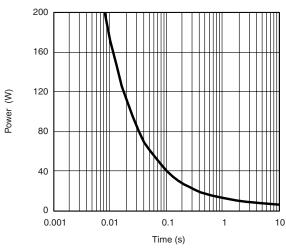
Source-Drain Diode Forward Voltage



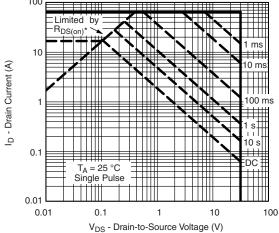
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

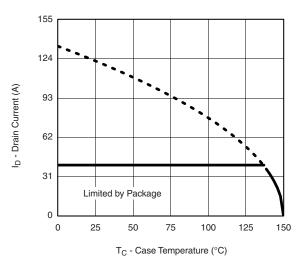
Safe Operating Area, Junction-to-Ambient



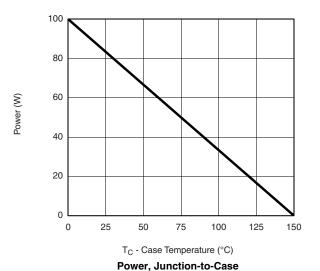


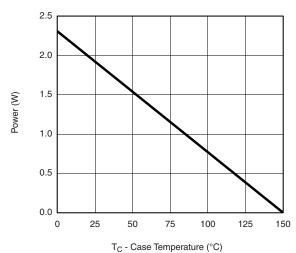
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### **Current Derating\***





Power, Junction-to-Ambient

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 $<sup>^{\</sup>star}$  The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 175  $^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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Datasheet of SI7664DP-T1-E3 - MOSFET N-CH 30V 40A PPAK SO-8

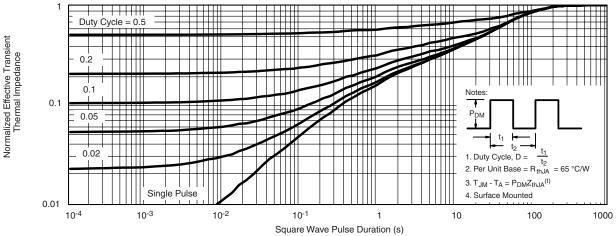
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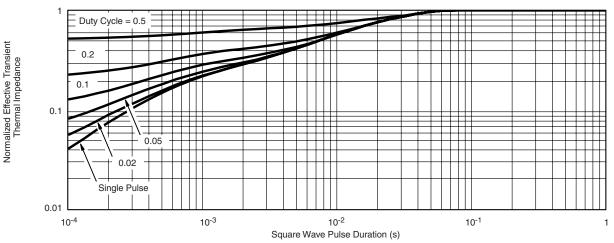
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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Datasheet of SI7664DP-T1-E3 - MOSFET N-CH 30V 40A PPAK SO-8

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